The AFSEM™ -

Correlated in-situ AFM & SEM & EDX analysis of nanostructured materials

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The AFSEM™ concept

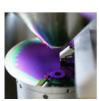


AFSEM™ correlated microscopy

AFSEM™ is a novel AFM platform specifically designed and developed for integration into other host systems, such as SEM or Dual-beam (SEM/FIB) microscopes. Its open design allows to simultaneously operate SEM/FIB and AFSEM™ inside the SEM/FIB vacuum chamber. The AFSEM™ is capable of imaging any sample your SEM or Dual-beam accepts.

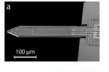
Main benefits:

- Direct 3D information
- Correlated Microscopy at highest SEM resolution of exactly the same sample position by SEM/FIB, EDX and AFSEM™
- No air exposure of the sample during interactive analysis by different methods
- Nanometer Scale Analysis before SEM sample contamination
- Ease of Use No AFM laser alignment due to self-sensing cantilever technology
- AFSEM™ accepts any Sample the host system accepts

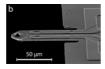




Self-Sensing Cantilever Technology

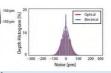








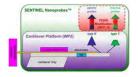


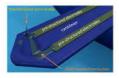


Electrical Noise Level of 0.32 Å for Self-Sensing Cantilever equals Optical Noise Level

M. Dukic, J. D. Adams and G. E. Fantner. Scientific Reports 5, 16393 (2015)

Novel modular Nano-Toolbox





Conductive



Scanning-Thermal



Customized

- Ultra-Hard AFM Tips High-Aspect Ratio Tips
- 3D Tip-structures

Next generation of Self-Sensing cantilevers enables unique correlated analysis by AFSEM™

Applications AFSEM™ enables directly correlated in-situ electrical characterization of nanostructures AFSEM™ conductive map SEM image of 150 nm Au structure. AFSEM™ 3D topography AFSEM™ enables directly correlated in-situ AFM & SEM & electrical & EDX characterization of nanostructures Correlated AFSEM™ 3D topography & conductive map. Au Al₂O₃ Au Al₂O₃ Au Al₂O₃ A AESEM™ 3D Schematics of samp on siliconoxide. Correlated EDX hemical compositi analysis. Local distribution of siliconoxide. AFSEM™ enables *in-situ* micro-mechanical testing with nanometer resolution. Schematic setup of AFSEMTI and tensile stage inside SEM 3D topography of solder wire after 1% expansion (RMS = 51 nm). 3D topography of solder wire after 35% expansion (RMS = 189 nm).



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